B2BYM-PCB



1.5-3.5 Male Straight B2B, PCB Type

Product Classification

Product Type Device connector

General Specifications

Body Style Straight

Inner Contact Attachment Method Solder

Inner Contact Plating Silver

Interface 1.5-3.5 Male

Mounting Angle Straight

Outer Contact Plating Tin | Trimetal

Dimensions

 Height
 9 mm | 0.354 in

 Width
 9 mm | 0.354 in

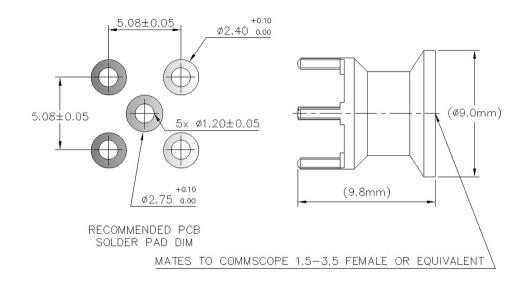
Width 9 mm | 0.354 in

 Length
 9.8 mm | 0.386 in

 Diameter
 9 mm | 0.354 in

Outline Drawing

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Electrical Specifications

3rd Order IMD at Frequency -110 dBm @ 3500 MHz | -112 dBm @ 1800 MHz | -112 dBm @ 910 MHz

3rd Order IMD Test Method Two +43 dBm carriers

Insertion Loss, maximum0.1 dBConnector Impedance50 ohmdc Test Voltage1000 VInner Contact Resistance, maximum2 mOhm

Insulation Resistance, minimum 5000 MOhm

Operating Frequency Band 0 - 6000 MHz

Outer Contact Resistance, maximum2 mOhmRF Operating Voltage, maximum (vrms)500 V

VSWR/Return Loss

Frequency Band	VSWR	Return Loss (dB)
450-2200 MHz	1.065	30.04
2200-3800 MHz	1.065	30.04
3800-4200 MHz	1.083	27.99
4200-6000 MHz	1.222	20.01

Mechanical Specifications

COMMSCOPE®

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PCB Attachment Through-hole

Insertion Force 15 N | 3.372 lbf

Interface Durability 100 cycles

Interface Durability Method IEC 61169-4:17

Mechanical Shock Test Method IEC 60068-2-27

Radial Float/Misalignment 2.7 °

Environmental Specifications

Operating Temperature $-55 \,^{\circ}\text{C}$ to $+85 \,^{\circ}\text{C}$ (-67 $^{\circ}\text{F}$ to $+185 \,^{\circ}\text{F}$)

Storage Temperature $-65 \,^{\circ}\text{C}$ to $+125 \,^{\circ}\text{C}$ (-85 $^{\circ}\text{F}$ to $+257 \,^{\circ}\text{F}$)

Attenuation, Ambient Temperature 20 °C | 68 °F

Average Power, Ambient Temperature 40 °C | 104 °F

Average Power, Inner Conductor Temperature 100 °C | 212 °F

Corrosion Test Method IEC 60068-2-11

Thermal Shock Test Method IEC 60068-2-14

Vibration Test Method IEC 60068-2-6

Packaging and Weights

Weight, net 1.33 g | 0.003 lb

